



SOFTWARE SUSTAINABILITY CONSIDERATIONS FOR A PERFORMANCE LIBRARY

Intel® Math Kernel Library (Intel® MKL)

Faster, Scalable Code with Intel® Math Kernel Library

- Speeds computations for scientific, engineering, financial and machine learning applications by providing highly optimized, threaded, and vectorized math functions
- Provides key functionality for dense and sparse linear algebra (BLAS, LAPACK, PARDISO), FFTs, vector math, summary statistics, deep learning, splines and more
- Dispatches optimized code for each processor automatically without the need to branch code
- Optimized for single core vectorization and cache utilization
- Automatic parallelism for multi-core and many-core
- Scales from core to clusters
- Available at no cost and royalty free
- Great performance with minimal effort!

INTEL® MKL OFFERS...

DENSE AND SPARSE LINEAR ALGEBRA

FAST FOURIER TRANSFORMS

VECTOR MATH

VECTOR RNGS

FAST POISSON SOLVER

AND MORE!

Available as standalone or as a part of [Intel® Parallel Studio XE](#) and [Intel® System Studio](#)

Intel® Architecture Platforms

Operating System: Windows*, Linux*, MacOS^{1*}



[Optimization Notice](#)

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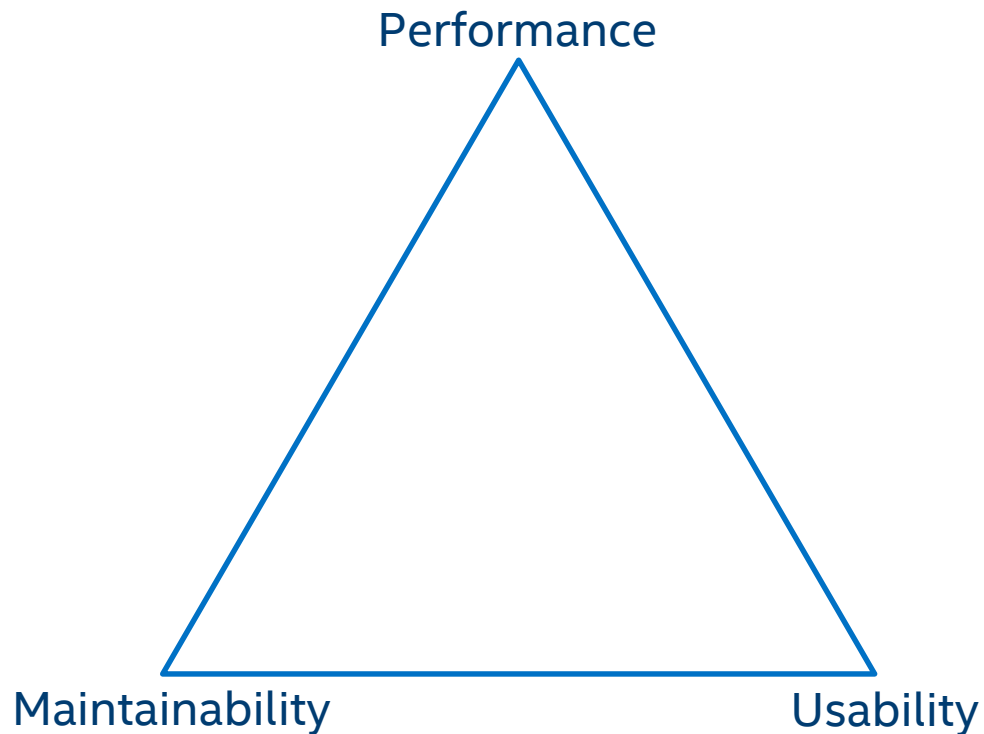
¹ Available only in Intel® Parallel Studio Composer Edition.



Intel MKL - 25 Years of Features and Performance

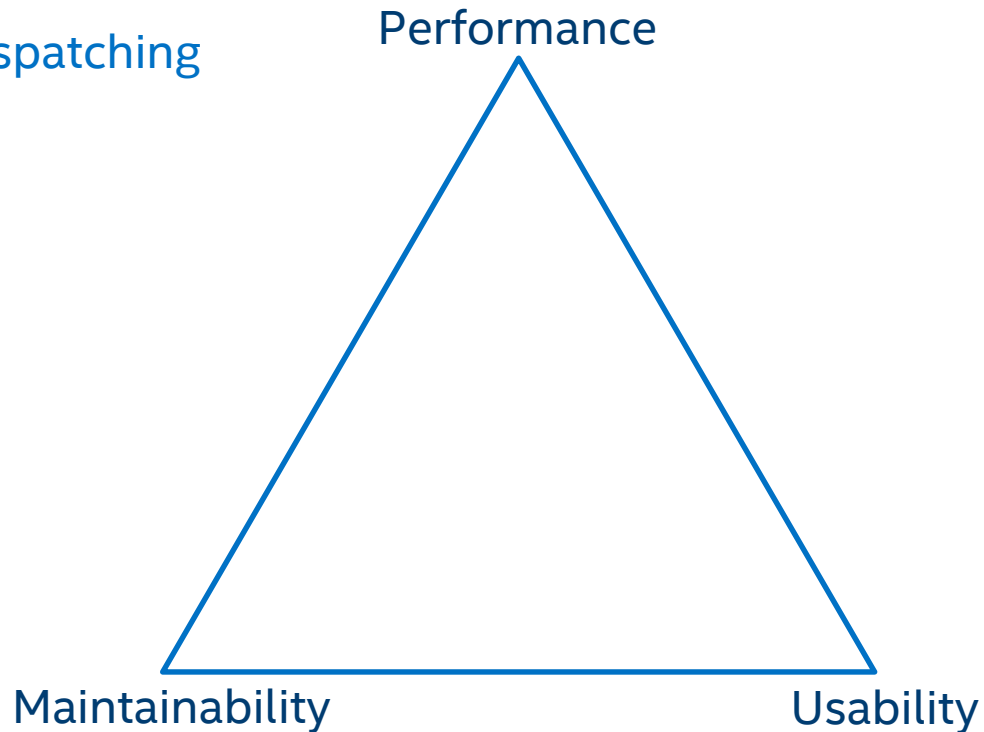
Year	Intel MKL Release	Processor	ISA	Features
1994	Intel® BLAS Library for Pentium Processor	Pentium	x87	BLAS
		Pentium II		
1996	Intel MKL 1.0			BLAS 3 Threaded
	2.0		MMX	2D FFTs
1998	2.1			Sparse Level 1 BLAS
	3.0	Pentium III	Intel® SSE	LAPACK
2000	4.0			Vector Math
	5.0	Pentium 4	Intel® SSE2	
2002	6.0	Itanium®		DFTI & Vector Statistics
	7.0			PARDISO* & ScaLAPACK
2004	7.1	EM64T (Prescott)	Intel® SSE3	
	8.0	Nacona		Sparse L2/L3 BLAS & F95
2006	9.0	Merom	Intel® SSSE3	Trig Transforms & Poisson Solver
	9.1	Penryn	Intel® SSE4.1	Trust Region & Linpack Benchmark
2008	10.0/10.1			Out-of-core PARDISO*
	10.2	Xeon E5* (Nehalem)	Intel® SSE4.2	LAPACK 3.2
2010	10.3			LAPACK & Data Fitting
		Xeon E5* (Westmere)		
2012	11.0	E5 (Sandy Bridge) & Intel Xeon® Phi (KNC)	Intel® AVX	Reproducibility & Extended Eigensolver & Automatic Offload
	11.1	E5 V2 (Ivybridge)		Reproducibility Enhancements
2014	11.2	E5 V3 (Haswell)	Intel® AVX2	Cluster Direct Sparse Solver & LAPACK 3.5 & Verbose Mode
	11.3			Community Licenses & Sparse Inspector Executor & TBB Support
2016	2017	E5 V4 (Broadwell) & Intel Xeon® Phi (KNL)	Intel® AVX512	Deep Neural Networks
	2018	Intel Xeon® Processor (Skylake Server)		Compact BLAS and LAPACK & Integer GEMM
2018	2019			JIT GEMM & Sparse QR Solvers

Software Sustainability Triangle



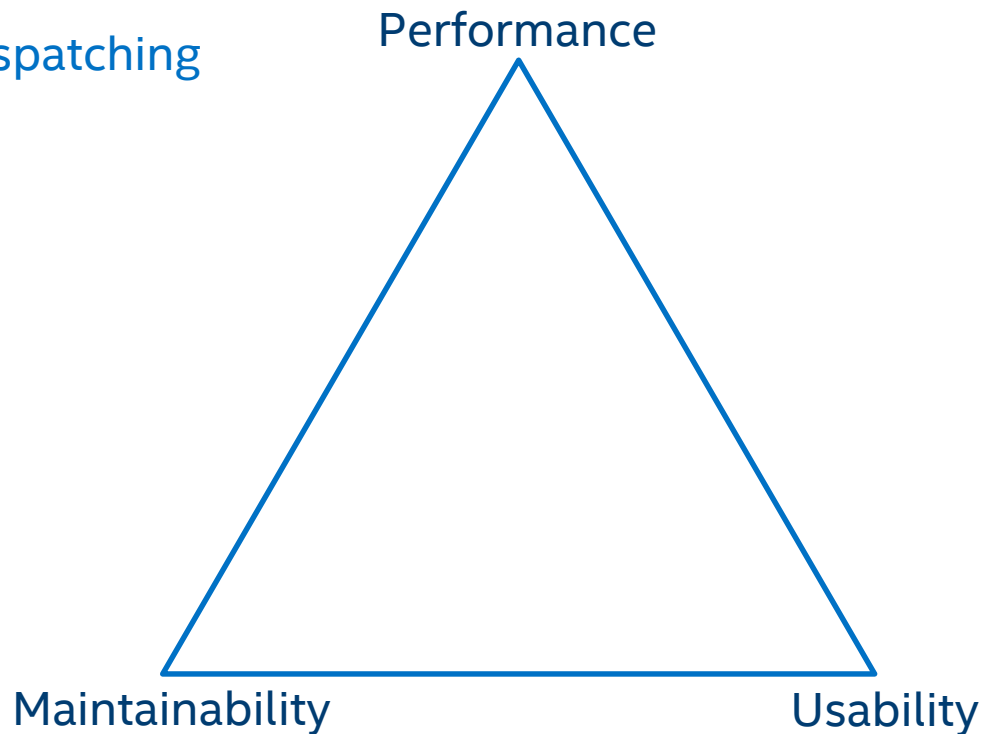
Software Sustainability Triangle

- Automatic dispatching



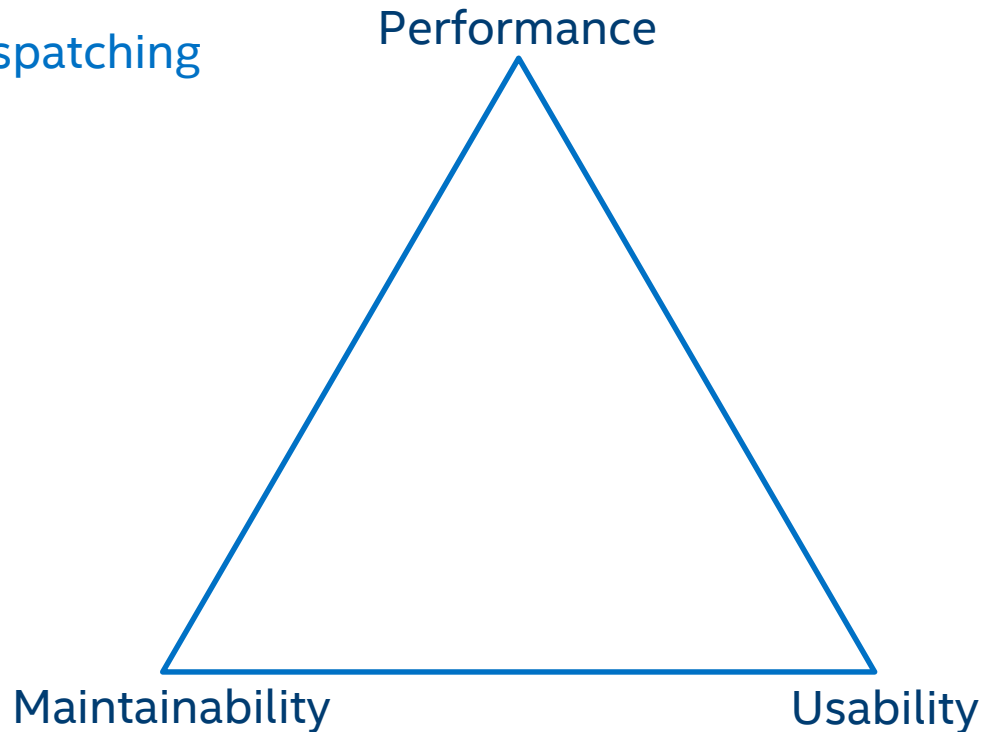
Software Sustainability Triangle

- Automatic dispatching
- APIs



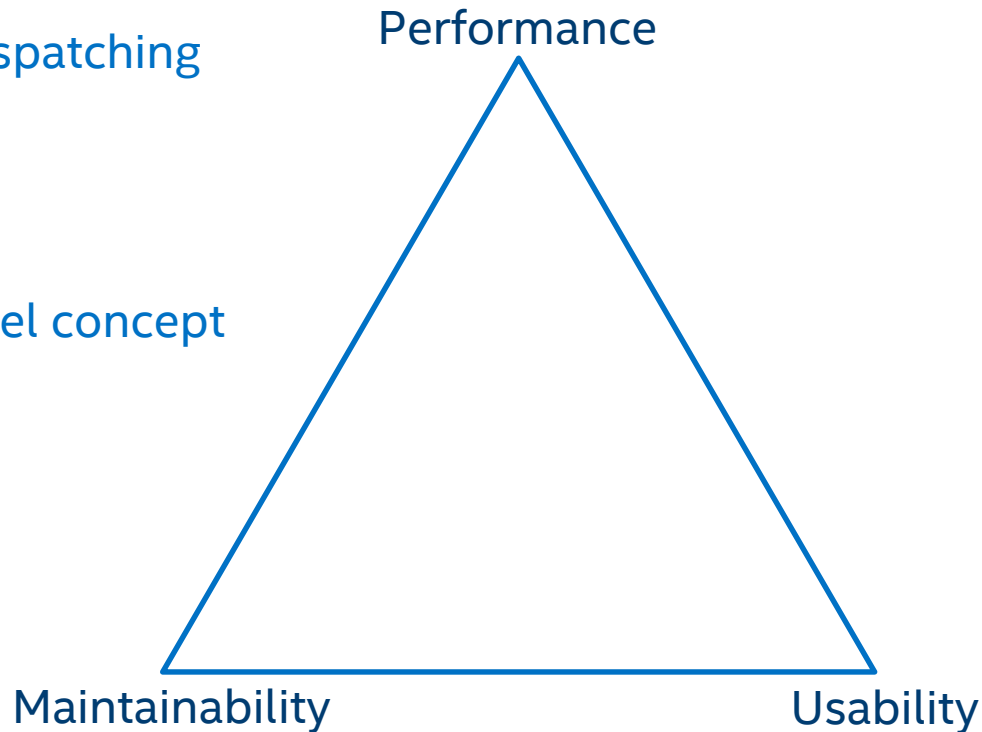
Software Sustainability Triangle

- Automatic dispatching
- APIs
- Portability



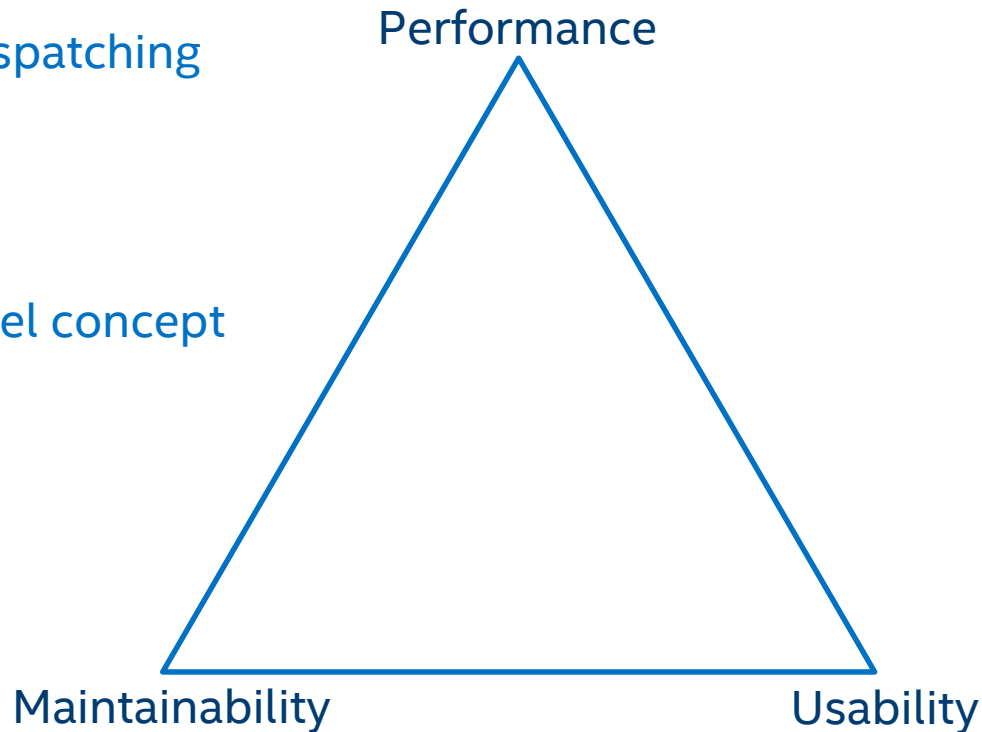
Software Sustainability Triangle

- Automatic dispatching
- APIs
- Portability
- Layered model concept



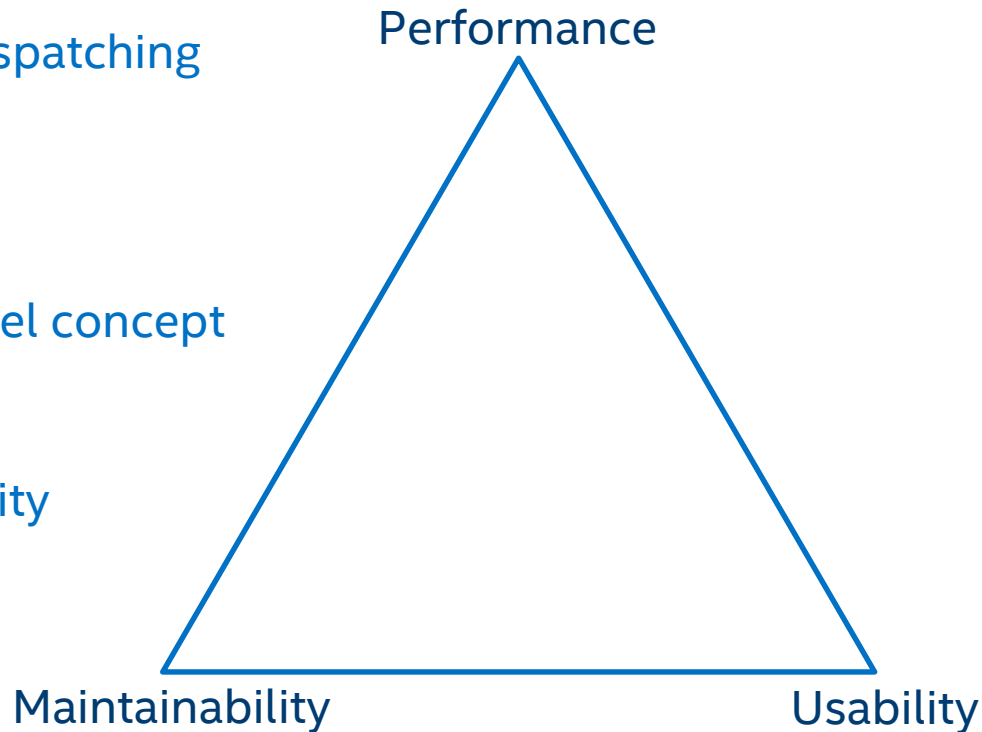
Software Sustainability Triangle

- Automatic dispatching
- APIs
- Portability
- Layered model concept
- Link line

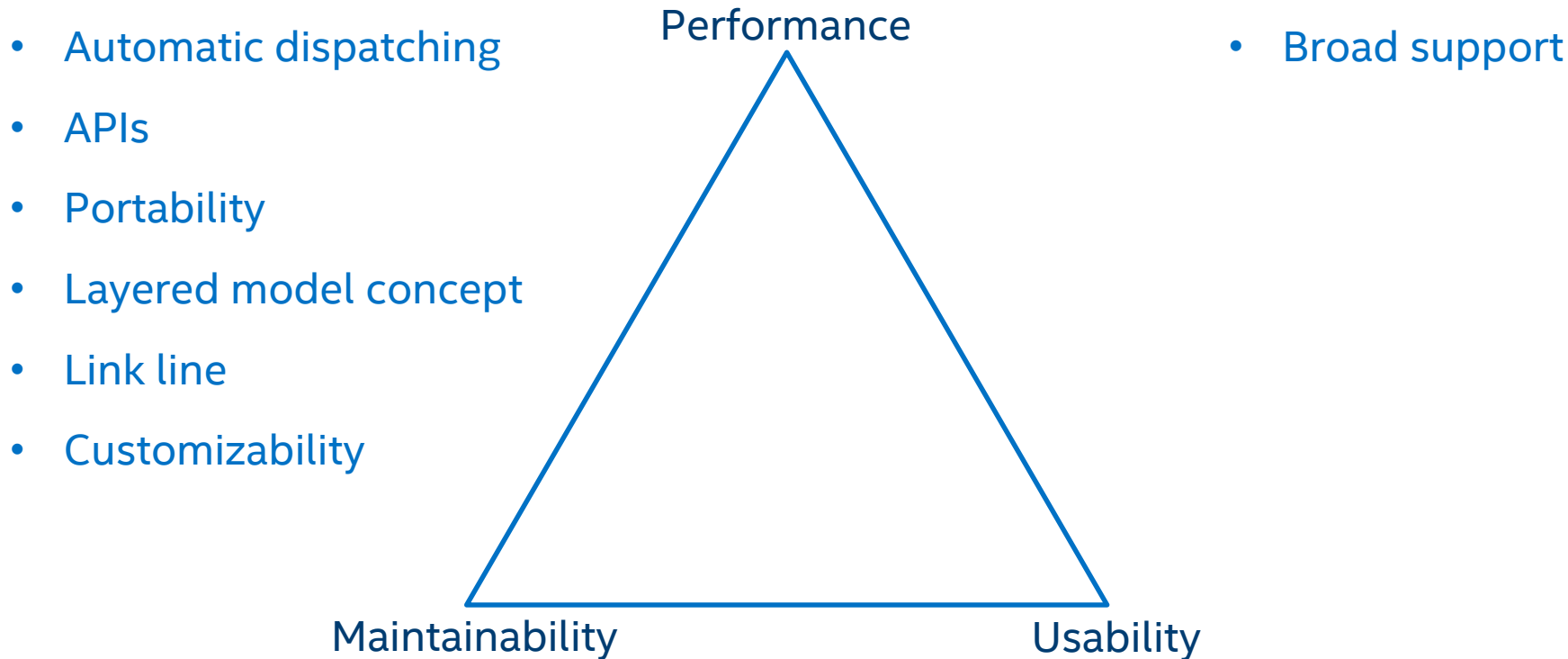


Software Sustainability Triangle

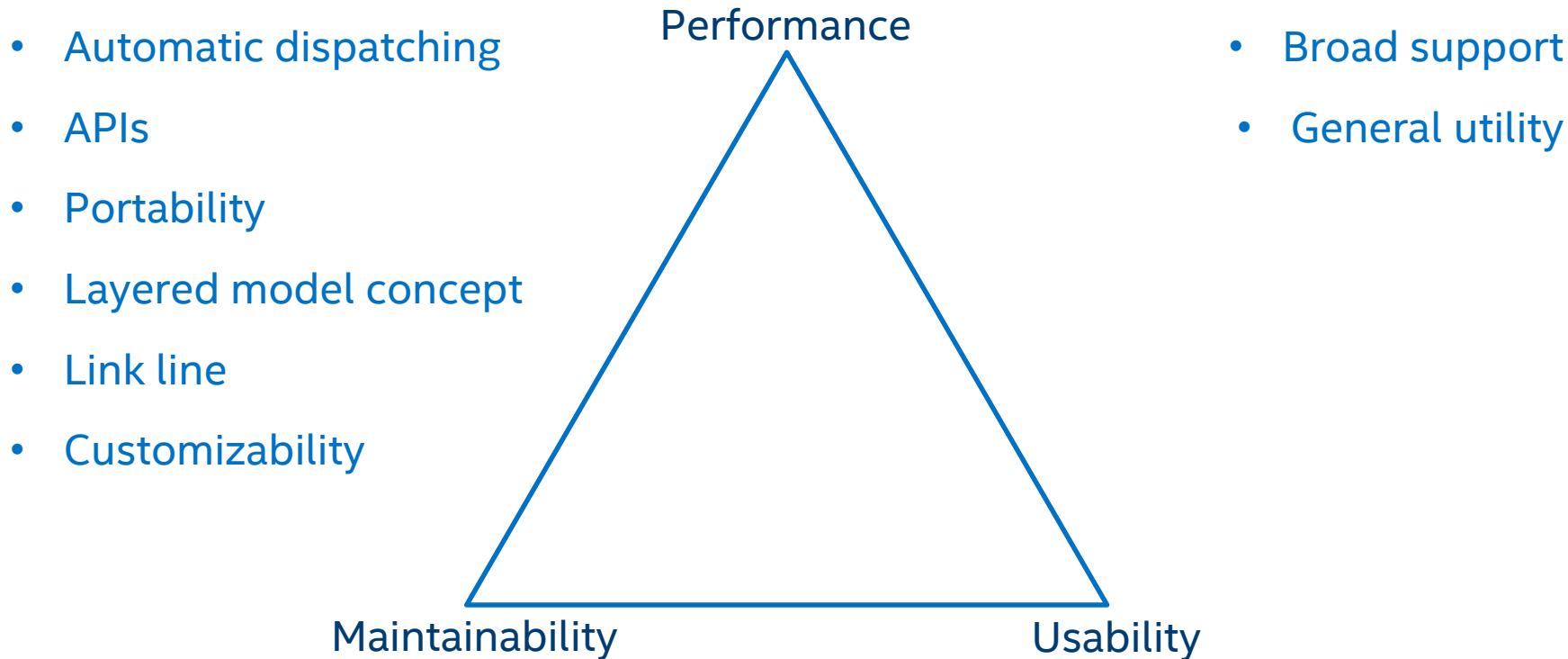
- Automatic dispatching
- APIs
- Portability
- Layered model concept
- Link line
- Customizability



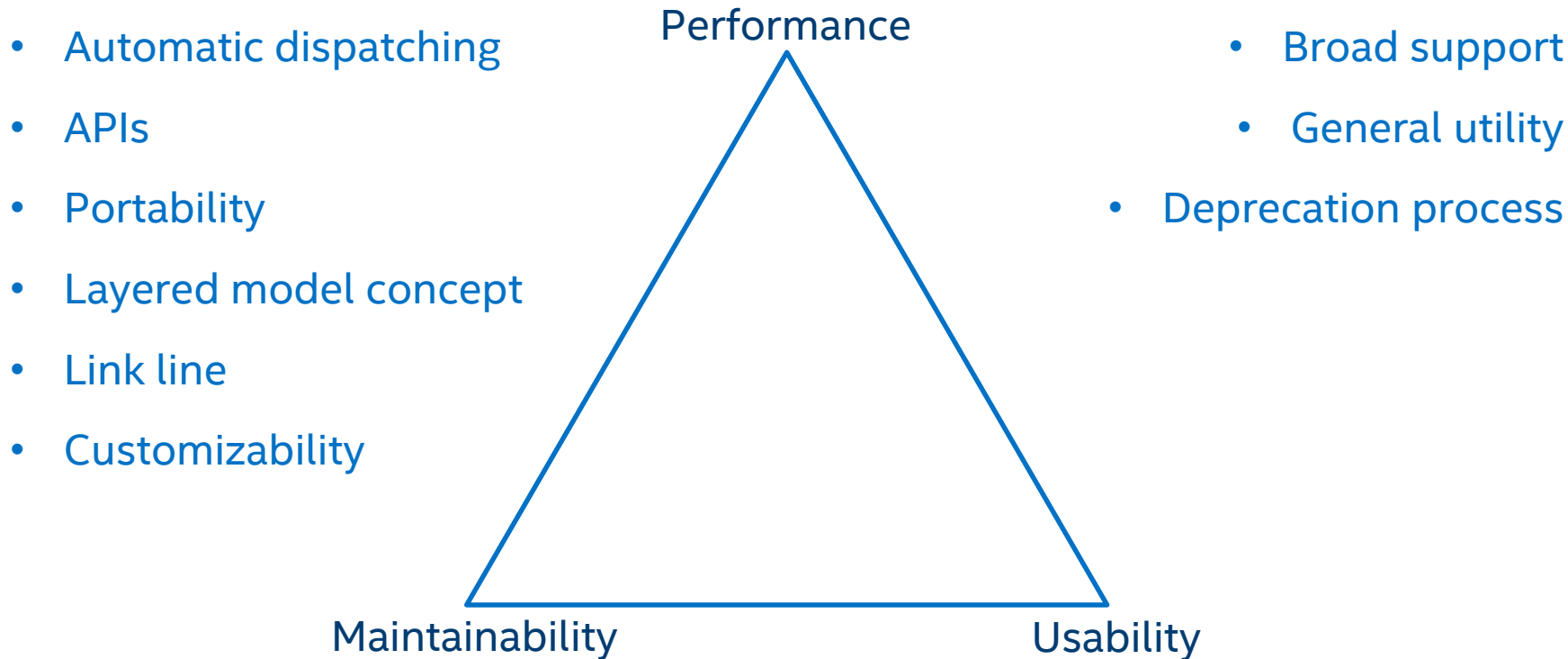
Software Sustainability Triangle



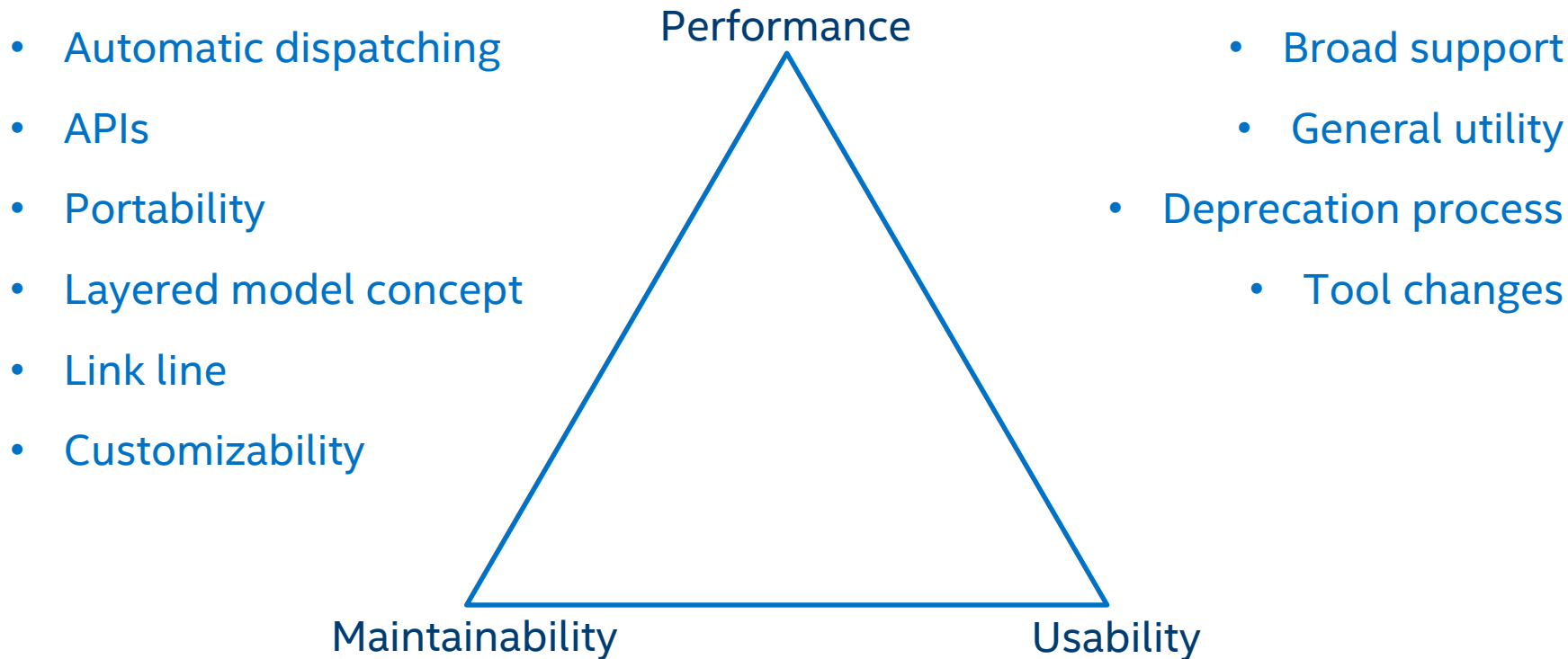
Software Sustainability Triangle



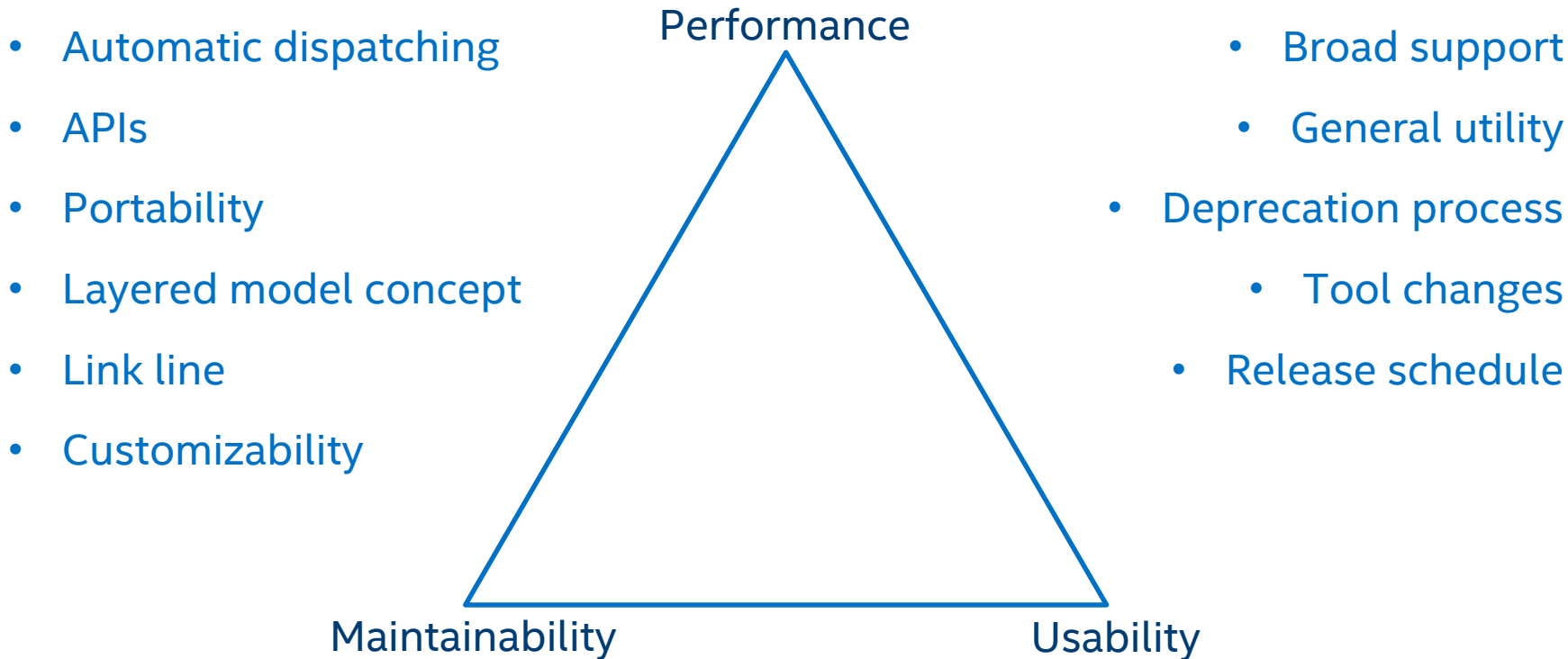
Software Sustainability Triangle



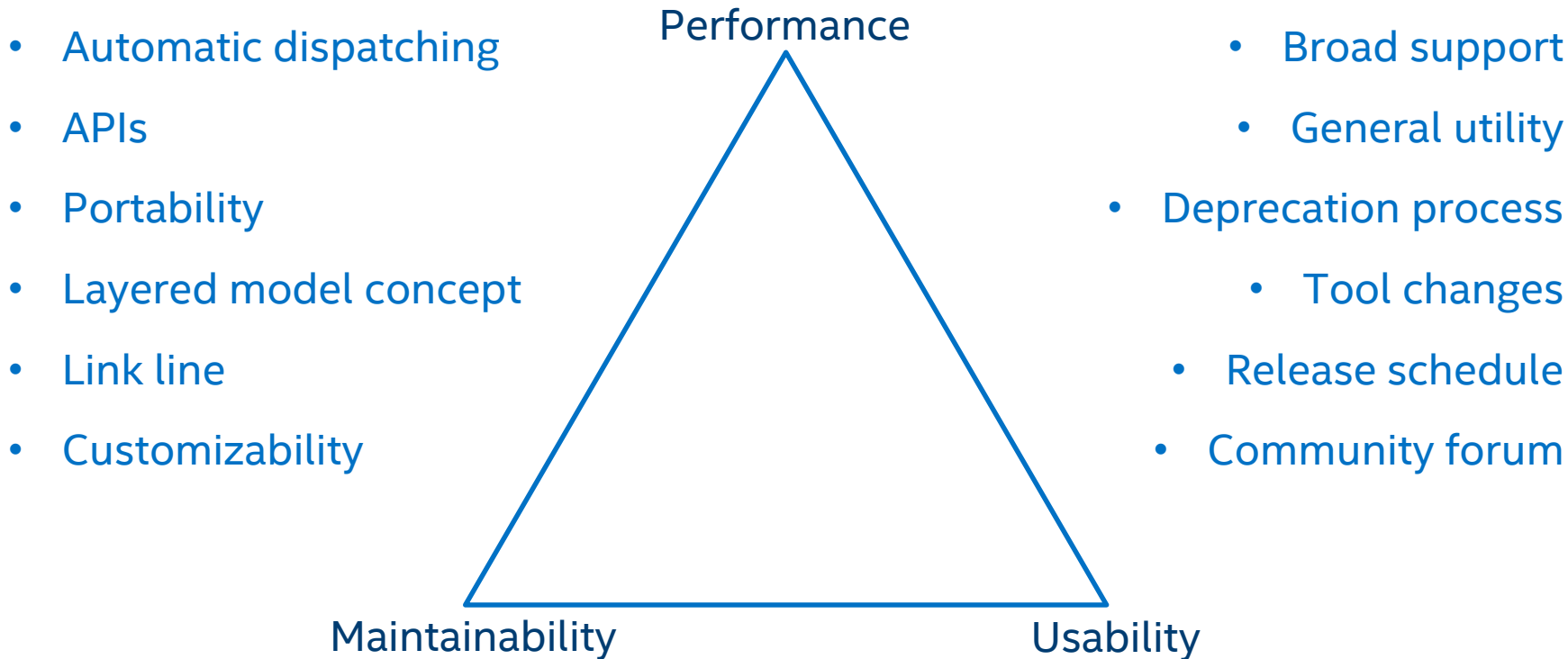
Software Sustainability Triangle



Software Sustainability Triangle



Software Sustainability Triangle



Summary

- Intel MKL provides 25 years of features and performance
- Strive to be relevant over a long period of time
- Need to anticipate change
- Trade-off analysis between performance, maintainability, usability

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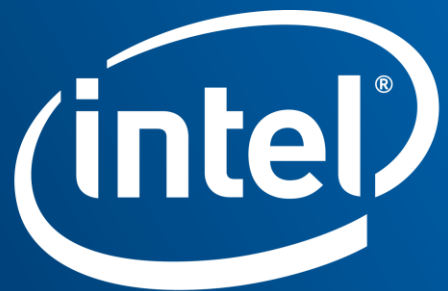
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